

	<b>PMP9760_BOM</b>					
<b>COUNT</b>	<b>RefDes</b>	<b>Value</b>	<b>Description</b>	<b>Size</b>	<b>Part Number</b>	<b>MFR</b>
1	CADD	10uF	Capacitor, Ceramic, 25V, X5R, 20%	0805	GRM21BR61E106MA73	muRata
2	C2, C4	22uF	Capacitor, Ceramic, 10V, X5R, 20%	0805	GRM21BR61A226ME44L	muRata
1	L1	22uH	Inductor, SMT, 0.78A, 190milliohm	4.8 x 4.8 mm	LPS5030-223MR	Coilcraft
1	R4	2.00M	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R5	383k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R6	100	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	U1	TPS62125DSG	IC, 300mA Buck Converter with Adjustable Enable Threshold	2 x 2 mm	TPS62125DSG	TI
	Other reference designators left open					

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